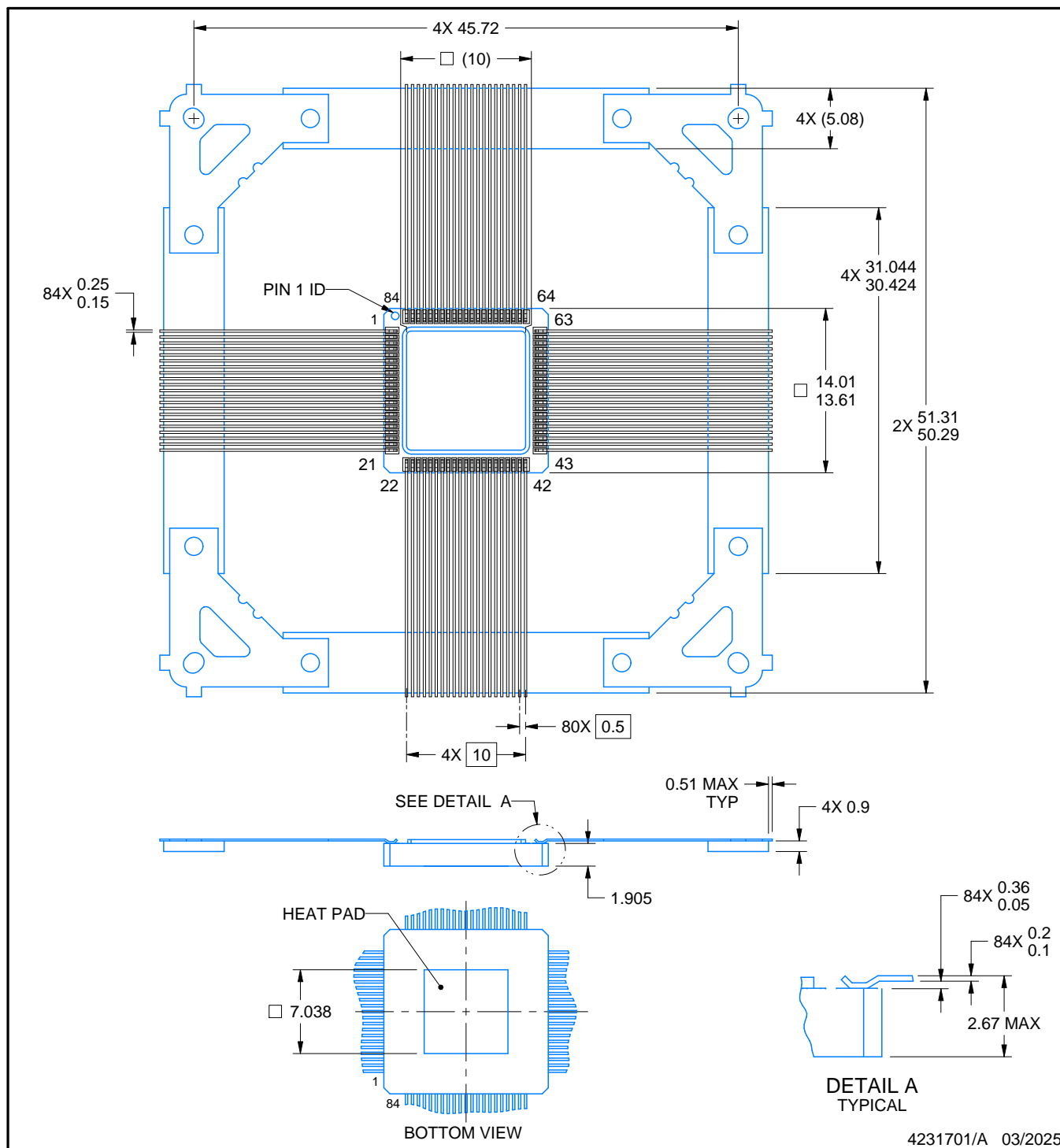




HFQ0084A

CFP - 2.67 mm max height

CFP



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Ceramic quad flatpack with flat leads brazed to non-conductive tie bar carrier.
4. This package is hermetically sealed with a metal lid.
5. The leads are gold plated and can be solder dipped.
6. The lid and the heat sink are connected to ground leads.

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